

Freescale Semiconductor

Application Note

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MSC8144 CLKIN and PCI_CLK_IN Board Layout

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This application provides an example that implements a layout design for the MSC8144 DSP CLKIN circuit. The same guidelines apply to the PCI_CLK_IN circuit.

The example layout uses the following components:

- Oscillator: PRECIDIP part 11093-30841-001.
- Clock Buffer: ICS part ICS551MLF.

NOTE

These parts are identified for example purposes only. Use of these part in this application note does not imply a requirement or recommendation for individual system designs.

NOTE

While this application note is specific for the MSC8144, it also applies to the MSC8144E and MSC8144EC devices.

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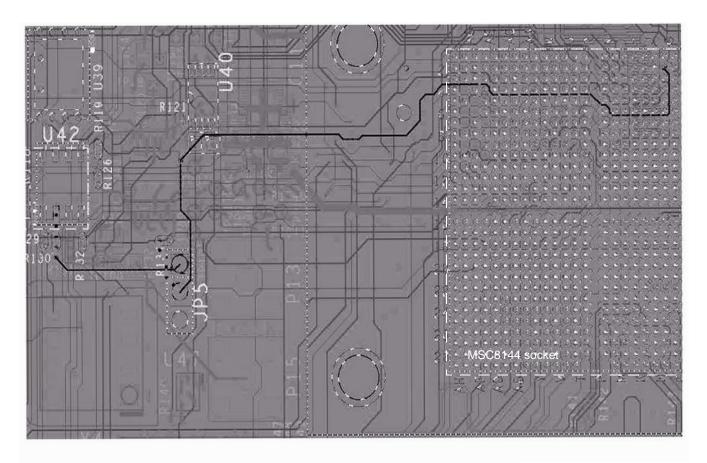




CLKIN Signal Layout Example

1 CLKIN Signal Layout Example

Figure 1 shows an example layout for the CLKIN signal path.



Note: Trace length is about 4 inches.

- U42 is the serial clock buffer.
- R130 is a 33 Ω serial termination resistor.
- J5 is a jumper connection.
- R131 is an optional parallel termination resistor.

Figure 1. Route from Buffer to CLKIN Signal Connection



2 Route from the Oscillator to the Clock Buffer

Figure 2 shows an example layout for the signal path route from the oscillator to the clock buffer.

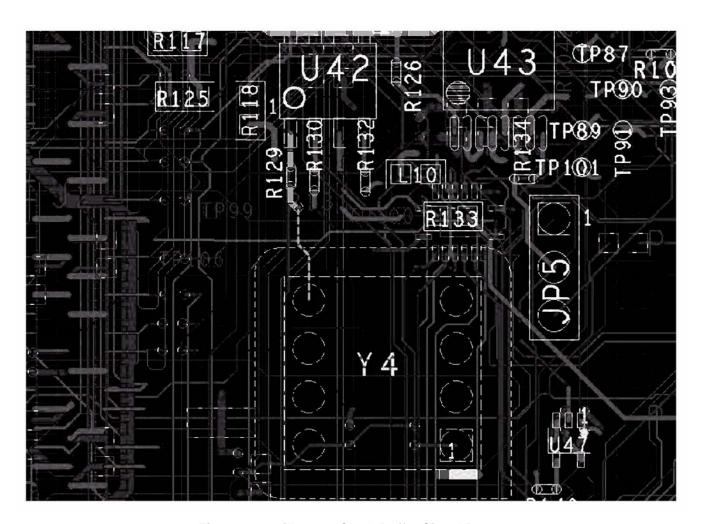


Figure 2. Oscillator to Clock Buffer Signal Route

3 Guidelines

- 1. Route clock traces with 50 Ω impedance.
- 2. To prevent signal reflection, use a serial termination resistor placed close to the CLKIN buffer. Use the following equation to compute the required termination value (Rterm):

where Rim = trace characteristic impedance Rbuf = clock buffer internal impedance.

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